

PART NUMBER**54366AJB-ROCV****Rochester Electronics****Manufactured Components**

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - Class Q Military
 - Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

SN54366, 54LS366, 74366

Hex Bus Drivers with 3-State Outputs

These Hex buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus oriented receivers and transmitters. The designer has choice of selected combinations of inverting and noninverting outputs, symmetrical G (active-low control) inputs.

These devices feature high fan-out, improved fan-in, and can be used to drive terminated lines down to 133 ohms.

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FOR REFERENCE ONLY

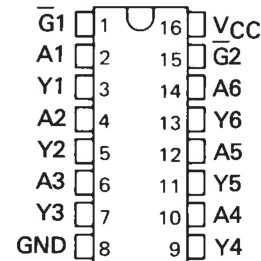
SN54365A THRU SN54368A, SN54LS365A THRU SN54LS368A SN74365A THRU SN74368A, SN74LS365A THRU SN74LS368A HEX BUS DRIVERS WITH 3-STATE OUTPUTS

DECEMBER 1983—REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
 - Choice of True or Inverting Outputs
 - Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
 - Dependable Texas Instruments Quality and Reliability
- '365A, '367A, 'LS365A, 'LS367A True Outputs
'366A, '368A, 'LS366A, 'LS368A Inverting Outputs

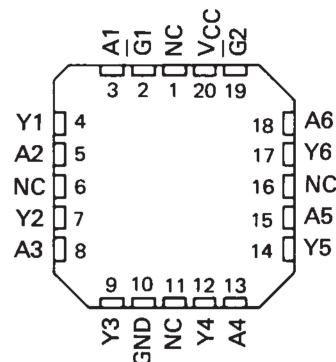
SN54365A, 366A, SN54LS365A, 366A . . . J PACKAGE
SN74365A, 366A . . . N PACKAGE
SN74LS365A, SN74LS366A . . . D OR N PACKAGE

(TOP VIEW)



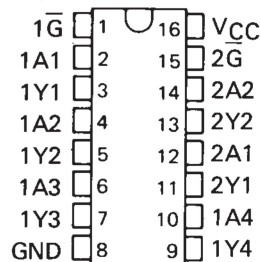
SN54LS365A, SN54LS366A . . . FK PACKAGE

(TOP VIEW)



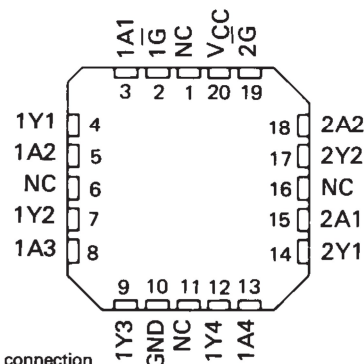
SN54367A, 368A, SN54LS367A, 368A . . . J PACKAGE
SN74367A, 368A . . . N PACKAGE
SN74LS367A, SN74LS368A . . . D OR N PACKAGE

(TOP VIEW)



SN54LS367A, SN54LS368A . . . FK PACKAGE

(TOP VIEW)



NC - No internal connection

description

These Hex buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus oriented receivers and transmitters. The designer has choice of selected combinations of inverting and noninverting outputs, symmetrical $\bar{G}$ (active-low control) inputs.

These devices feature high fan-out, improved fan-in, and can be used to drive terminated lines down to 133 ohms.

The SN54365A thru SN54368A and SN54LS365A thru SN54LS368A are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74365A thru SN74368A and SN74LS365A thru SN74LS368A are characterized for operation from 0°C to 70°C .

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TTL Devices

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

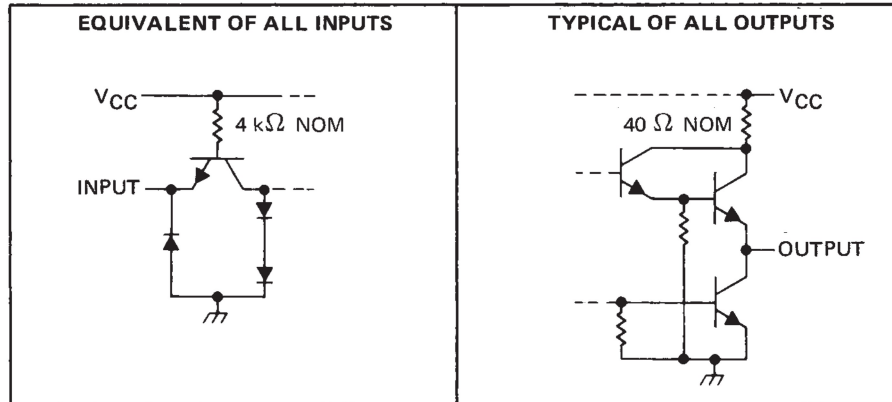
TEXAS
INSTRUMENTS

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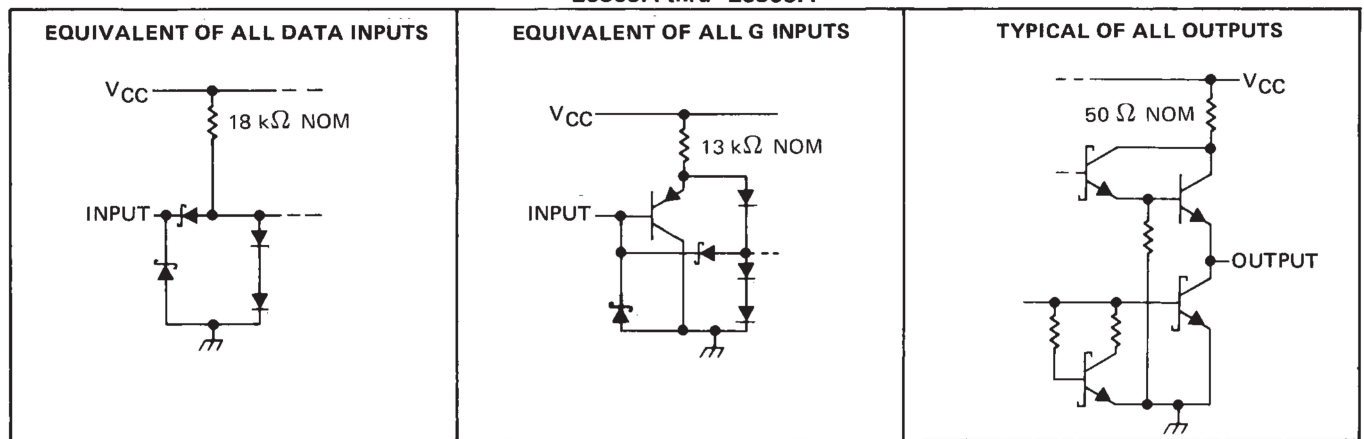
SN54365A THRU SN54368A, SN54LS365A THRU SN54LS368A SN74365A THRU SN74368A, SN74LS365A THRU SN74LS368A HEX BUS DRIVERS WITH 3-STATE OUTPUTS

schematics of inputs and outputs

'365A thru '368A

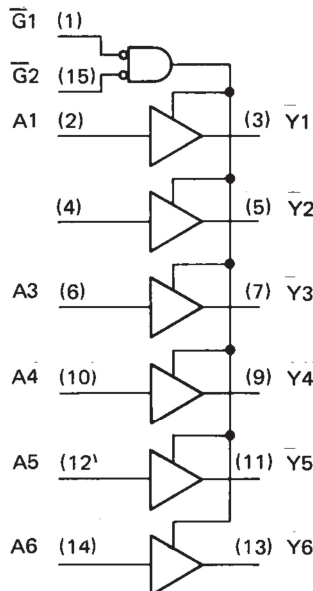


'LS365A thru 'LS368A

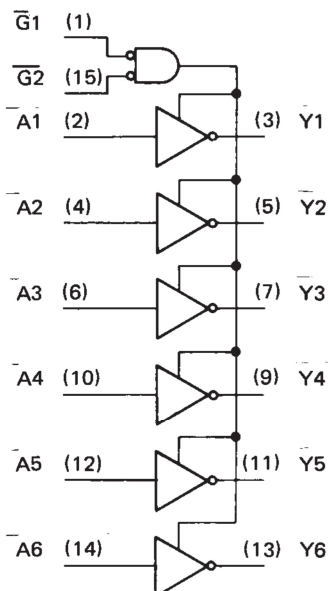


logic diagrams (positive logic)

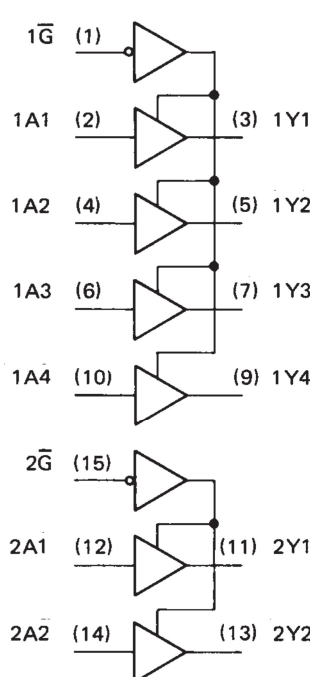
'365A, 'LS365A



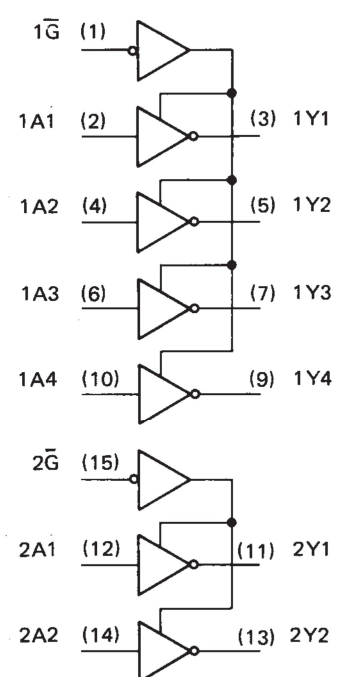
'366A, 'LS366A



'367A, 'LS367A



'368A, 'LS368A



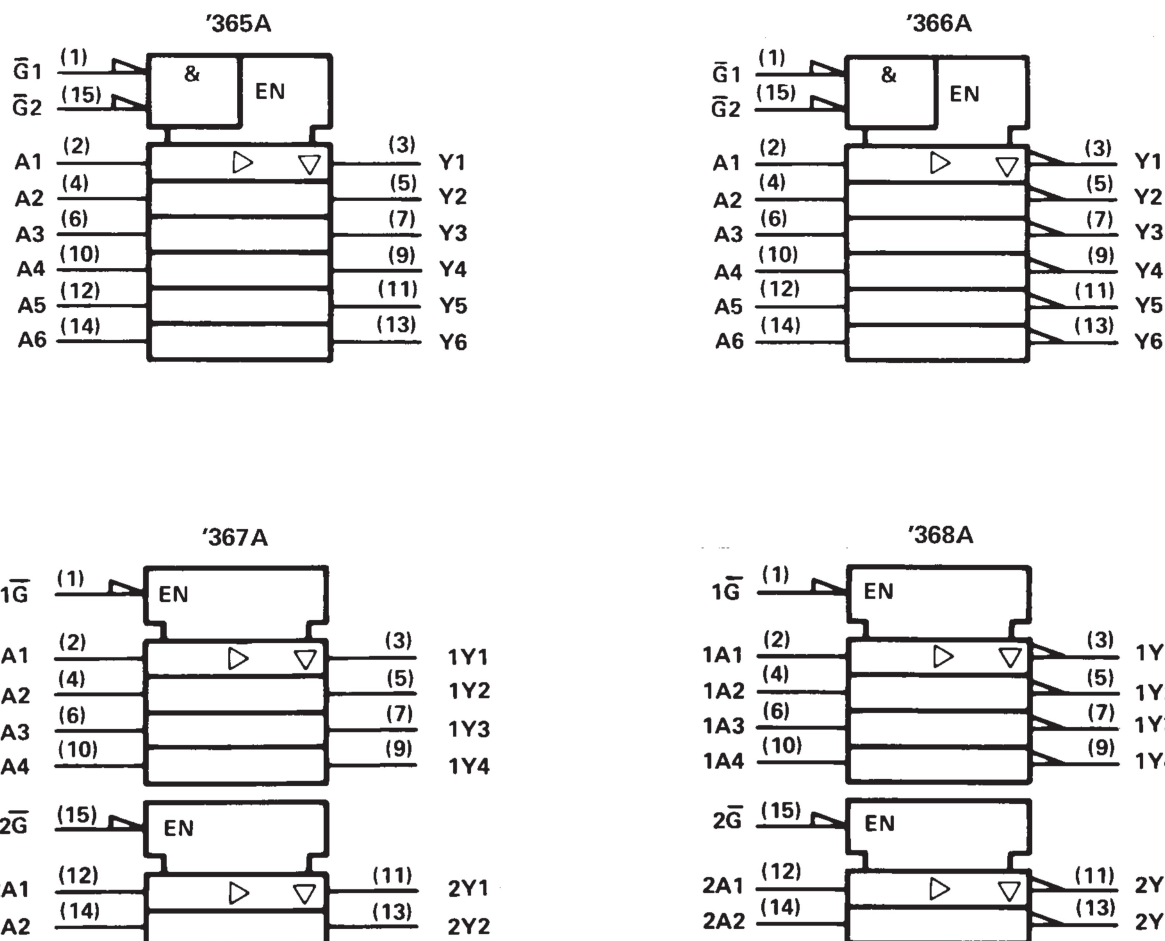
Pin numbers shown are for D, J, and N packages.

TEXAS
INSTRUMENTS

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SN54365A THRU SN54368A, SN54LS365A THRU SN54LS368A SN74365A THRU SN74368A, SN74LS365A THRU SN74LS368A HEX BUS DRIVERS WITH 3-STATE OUTPUTS

logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage: '365A, '366A, '367A, '368A	5.5 V
'LS365A, 'LS366A, 'LS367A, 'LS368A	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature: SN54'	– 55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	– 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

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TTL Devices

SN54365A, SN54367A
SN74365A, SN74367A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS

recommended operating conditions

	SN54365A SN54367A			SN74365A SN74367A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			0.8	V
I _{OH} High-level output current			− 2			− 5.2	mA
I _{OL} Low-level output current			32			32	mA
T _A Operating free-air temperature	− 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	SN54365A SN54367A			SN74365A SN74367A			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}	V _{CC} = MIN, I _I = − 12 mA			− 1.5			− 1.5	V
V _{OH}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = MAX	2.4	3.3		2.4	3.1		V
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 32 mA			0.4			0.4	V
I _{OZ}	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = 0.8 V, V _O = 2.4 V			40			40	μA
	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = 0.8 V, V _O = 0.4 V			− 40			− 40	
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.4 V			40			40	μA
I _{IL}	A Inputs V _{CC} = MAX, V _I = 0.5 V, Either $\bar{G}$ input at 2 V			− 40			− 40	μA
	V _{CC} = MAX, V _I = 0.4 V, Both $\bar{G}$ inputs at 0.4 V			− 1.6			− 1.6	mA
	$\bar{G}$ Inputs V _{CC} = MAX, V _I = 0.4 V			− 1.6			− 1.6	
I _{OS} §	V _{CC} = MAX	− 40		− 130	− 40		− 130	mA
I _{CC}	V _{CC} = MAX, Data inputs = 0 V, Output controls = 4.5 V		65	85		65	85	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PLH}	Any	Y	R _L = 400 Ω, C _L = 50 pF			16	ns
t _{PHL}						22	ns
t _{PZH}						35	ns
t _{PZL}						37	ns
t _{PHZ}			R _L = 400 Ω, C _L = 5 pF			11	ns
t _{PLZ}						27	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54366A, SN54368A
SN74366A, SN74368A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS

recommended operating conditions

	SN54366A SN54368A			SN74366A SN74368A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.8			0.8	V
I_{OH} High-level output current			– 2			– 5.2	mA
I_{OL} Low-level output current			32			32	mA
T_A Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54366A SN54368A			SN74366A SN74368A			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	$V_{CC} = \text{MIN},$ $I_I = -12 \text{ mA}$				– 1.5			– 1.5	V
V_{OH}	$V_{CC} = \text{MIN},$ $I_{OH} = \text{MAX}$ $V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V},$		2.4	3.3		2.4	3.1		V
V_{OL}	$V_{CC} = \text{MIN},$ $I_{OL} = 32 \text{ mA}$ $V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V},$				0.4			0.4	V
I_{OZ}	$V_{CC} = \text{MAX},$ $V_O = 2.4 \text{ V}$ $V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V},$				40			40	μA
	$V_{CC} = \text{MAX},$ $V_O = 0.4 \text{ V}$ $V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V},$				– 40			– 40	
I_I	$V_{CC} = \text{MAX},$ $V_I = 5.5 \text{ V}$				1			1	mA
I_{IH}	$V_{CC} = \text{MAX},$ $V_I = 2.4 \text{ V}$				40			40	μA
I_{IL}	A Inputs $V_{CC} = \text{MAX},$ $V_I = 0.5 \text{ V},$ Either $\bar{G}$ input at 2 V				– 40			– 40	μA
	$V_{CC} = \text{MAX},$ $V_I = 0.4 \text{ V},$ Both $\bar{G}$ inputs at 0.4 V				– 1.6			– 1.6	mA
	$\bar{G}$ Inputs $V_{CC} = \text{MAX},$ $V_I = 0.4 \text{ V}$				– 1.6			– 1.6	
$I_{OS}\$$	$V_{CC} = \text{MAX}$		– 40		– 130	– 40		– 130	mA
I_{CC}	$V_{CC} = \text{MAX},$ Data inputs = 0 V, Output controls = 4.5 V,			59	77		59	77	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}.$

§ Not more than one output should be shorted at a time.

switching characteristics, $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Y	$R_L = 400 \Omega,$ $C_L = 50 \text{ pF}$			17	ns
t_{PHL}						16	ns
t_{PZH}						35	ns
t_{PZL}						37	ns
t_{PHZ}			$R_L = 400 \Omega,$ $C_L = 5 \text{ pF}$			11	ns
t_{PLZ}						27	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

**SN54LS365A, SN54LS367A
SN74LS365A, SN74LS367A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS**

recommended operating conditions

	SN54LS365A SN54LS367A			SN74LS365A SN74LS367A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH} High-level input voltage	2			2			V
V_{IL} Low-level input voltage			0.7			0.8	V
I_{OH} High-level output current			− 1			− 2.6	mA
I_{OL} Low-level output current			12			24	mA
T_A Operating free-air temperature	− 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54LS365A SN54LS367A			SN74LS365A SN74LS367A			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$			− 1.5			− 1.5	V
V_{OH}		$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}, I_{OH} = \text{MAX}$	2.4	3.3		2.4	3.1		V
V_{OL}		$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}, I_{OL} = 12 \text{ mA}$		0.25	0.4		0.25	0.4	V
		$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V}, I_{OL} = 24 \text{ mA}$					0.35	0.5	
I_{OZ}		$V_{CC} = \text{MAX}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}, V_O = 2.4 \text{ V}$			20			20	μA
		$V_{CC} = \text{MAX}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}, V_O = 0.4 \text{ V}$			− 20			− 20	
I_I		$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$			0.1			0.1	mA
I_{IH}		$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			20			20	μA
I_{IL}	A Inputs	$V_{CC} = \text{MAX}, V_I = 0.5 \text{ V}, \text{ Either } \bar{G} \text{ input at } 2 \text{ V}$			− 20			− 20	μA
		$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}, \text{ Both } \bar{G} \text{ inputs at } 0.4 \text{ V}$			− 0.4			− 0.4	mA
	$\bar{G}$ Inputs	$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$			− 0.2			− 0.2	
$I_{OS}§$		$V_{CC} = \text{MAX}$	− 40		− 225	− 40		− 225	mA
I_{CC}		$V_{CC} = \text{MAX}, \text{ Data inputs} = 0 \text{ V}, \text{ Output controls} = 4.5 \text{ V},$		14	24		14	24	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

SN54LS365A, SN54LS367A
SN74LS365A, SN74LS367A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Y	$R_L = 667\ \Omega$, $C_L = 45\text{ pF}$		10	16	ns
t_{PHL}					9	22	ns
t_{PZH}					19	35	ns
t_{PZL}					24	40	ns
t_{PHZ}			$R_L = 667\ \Omega$, $C_L = 5\text{ pF}$			30	ns
t_{PLZ}						35	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

**SN54LS366A, SN54LS368A
SN74LS366A, SN74LS368A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS**

recommended operating conditions

	SN54LS366A SN54LS368A			SN74LS366A SN74LS368A			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			0.8	V
I _{OH} High-level output current			−1			−2.6	mA
I _{OL} Low-level output current			12			24	mA
T _A Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

2

TTL Devices

PARAMETER	TEST CONDITIONS†	SN54LS366A SN54LS368A			SN74LS366A SN74LS368A			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}	V _{CC} = MIN, I _I = −18 mA			−1.5			−1.5	V
V _{OH}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX, I _{OH} = MAX	2.4	3.3		2.4	3.1		V
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX, I _{OL} = 12 mA	0.25	0.4		0.25	0.4		V
	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 24 mA				0.35	0.5		
I _{OZ}	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = MAX, V _O = 2.4 V			20			20	μA
	V _{CC} = MAX, V _{IH} = 2 V, V _{IL} = MAX, V _O = 0.4 V			−20			−20	
I _I	V _{CC} = MAX, V _I = 7 V			0.1			0.1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			20			20	μA
I _{IL}	A Inputs, V _{CC} = MAX, V _I = 0.5 V, Either $\overline{G}$ input at 2 V			−20			−20	μA
	V _{CC} = MAX, V _I = 0.4 V, Both $\overline{G}$ inputs at 0.4 V			−0.4			−0.4	mA
	$\overline{G}$ Inputs, V _{CC} = MAX, V _I = 0.4 V			−0.2			−0.2	
I _{OS} §	V _{CC} = MAX	−40		−225	−40		−225	mA
I _{CC}	V _{CC} = MAX, Data inputs = 0 V, Output controls = 4.5 V		12	21		12	21	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

SN54LS366A, SN54LS368A
SN74LS366A, SN74LS368A
HEX BUS DRIVERS WITH 3-STATE OUTPUTS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Y	$R_L = 667\ \Omega$, $C_L = 45\text{ pF}$		7	15	ns
t_{PHL}					12	18	ns
t_{PZH}					18	35	ns
t_{PZL}					28	45	ns
t_{PHZ}			$R_L = 667\ \Omega$, $C_L = 5\text{ pF}$			32	ns
t_{PLZ}						35	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty (2)	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
5962-9687802QEA	OBSOLETE	CDIP	J	16	TBD	TBD	Call TI	Call TI	-55 to 125	
5962-9687802QFA	OBSOLETE	CFP	W	16	TBD	TBD	Call TI	Call TI	-55 to 125	
5962-9687802QFA	OBSOLETE	CFP	W	16	TBD	TBD	Call TI	Call TI	-55 to 125	
JM38510/16303BEA	OBSOLETE	CDIP	J	16	TBD	TBD	Call TI	Call TI	-55 to 125	
JM38510/16303BEA	OBSOLETE	CDIP	J	16	TBD	TBD	Call TI	Call TI	-55 to 125	
JM38510/16304BEA	OBSOLETE	CDIP	J	16	TBD	TBD	Call TI	Call TI	-55 to 125	
JM38510/16304BEA	OBSOLETE	CDIP	J	16	TBD	TBD	Call TI	Call TI	-55 to 125	
JM38510/32201B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32201B2A
JM38510/32201B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32201B2A
JM38510/32201BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BEA
JM38510/32201BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BEA
JM38510/32201BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BFA
JM38510/32201BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BFA
JM38510/32203B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32203B2A
JM38510/32203B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32203B2A
JM38510/32203BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BEA
JM38510/32203BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BEA
JM38510/32203BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BFA
JM38510/32203BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BFA
JM38510/32203SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SEA

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
JM38510/32203SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SEA
JM38510/32203SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SFA
JM38510/32203SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SFA
M38510/32201B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32201B2A
M38510/32201B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32201B2A
M38510/32201BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BEA
M38510/32201BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BEA
M38510/32201BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BFA
M38510/32201BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32201BFA
M38510/32203B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32203B2A
M38510/32203B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 32203B2A
M38510/32203BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BEA
M38510/32203BEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BEA
M38510/32203BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BFA
M38510/32203BFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203BFA
M38510/32203SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SEA
M38510/32203SEA	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SEA
M38510/32203SFA	ACTIVE	CFP	W	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SFA

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
M38510/32203SFA	ACTIVE	GFP	W	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 32203SFA
SN54365AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54365AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54366AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	SN54366AJ
SN54366AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	SN54366AJ
SN54367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SN54LS365AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS365AJ
SN54LS365AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS365AJ
SN54LS366AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS366AJ
SN54LS366AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS366AJ
SN54LS366AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS366AJ
SN54LS367AJ	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS367AJ
SN54LS367AJ	ACTIVE	CDIP	J	16	25	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS367AJ
SN54LS368AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS368AJ
SN54LS368AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS368AJ
SN74365AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74365AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74366AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74366AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74367AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74367AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74367AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74367AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74368AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74368AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
SN74368AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74368AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS365AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS365A
SN74LS365AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS365A
SN74LS365ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS365A
SN74LS365ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS365A
SN74LS365AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS365AN
SN74LS365AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS365AN
SN74LS365AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS365AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS365ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS365A
SN74LS365ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS365A
SN74LS366AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	
SN74LS366AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	
SN74LS366ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	
SN74LS366ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	
SN74LS366AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS366AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS367AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS367A
SN74LS367AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS367A
SN74LS367ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS367A
SN74LS367ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS367A

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
SN74LS367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70	
SN74LS367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70	
SN74LS367AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS367AN
SN74LS367AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS367AN
SN74LS367AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS367AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS367ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS367AN
SN74LS367ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS367AN
SN74LS367ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS367A
SN74LS367ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS367A
SN74LS368AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS368A
SN74LS368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70	
SN74LS368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	0 to 70	
SN74LS368AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS368AN
SN74LS368AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS368AN
SN74LS368AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
SN74LS368AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	0 to 70	
SN74LS368ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS368AN
SN74LS368ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS368AN
SN74LS368ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS368A
SN74LS368ANSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS368A
SNJ54365AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54365AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54366AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	5962-9687802QE A SNJ54366AJ
SNJ54366AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	5962-9687802QE A SNJ54366AJ
SNJ54366AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	5962-9687802QF A SNJ54366AW
SNJ54366AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	5962-9687802QF A SNJ54366AW
SNJ54367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54367AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54367AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54367AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54368AJ	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54368AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54368AW	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI	-55 to 125	
SNJ54LS365AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 365AFK
SNJ54LS365AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 365AFK

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
SNJ54LS365AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS365AJ
SNJ54LS365AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS365AJ
SNJ54LS365AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS365AW
SNJ54LS365AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS365AW
SNJ54LS366AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 366AFK
SNJ54LS366AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 366AFK
SNJ54LS366AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS366AJ
SNJ54LS366AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS366AJ
SNJ54LS366AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS366AW
SNJ54LS366AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS366AW
SNJ54LS367AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 367AFK
SNJ54LS367AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 367AFK
SNJ54LS367AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS367AJ
SNJ54LS367AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS367AJ
SNJ54LS367AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS367AW
SNJ54LS367AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS367AW
SNJ54LS368AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 368AFK
SNJ54LS368AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 368AFK
SNJ54LS368AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS368AJ
SNJ54LS368AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS368AJ

PACKAGE OPTION ADDENDUM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)
SNJ54LS368AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS368AW
SNJ54LS368AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS368AW

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54365A, SN54366A, SN54367A, SN54368A, SN54LS365A, SN54LS366A, SN54LS367A, SN54LS368A, SN74365A, SN74366A, SN74367A, SN74368A, SN74LS365A, SN74LS366A, SN74LS367A, SN74LS368A :

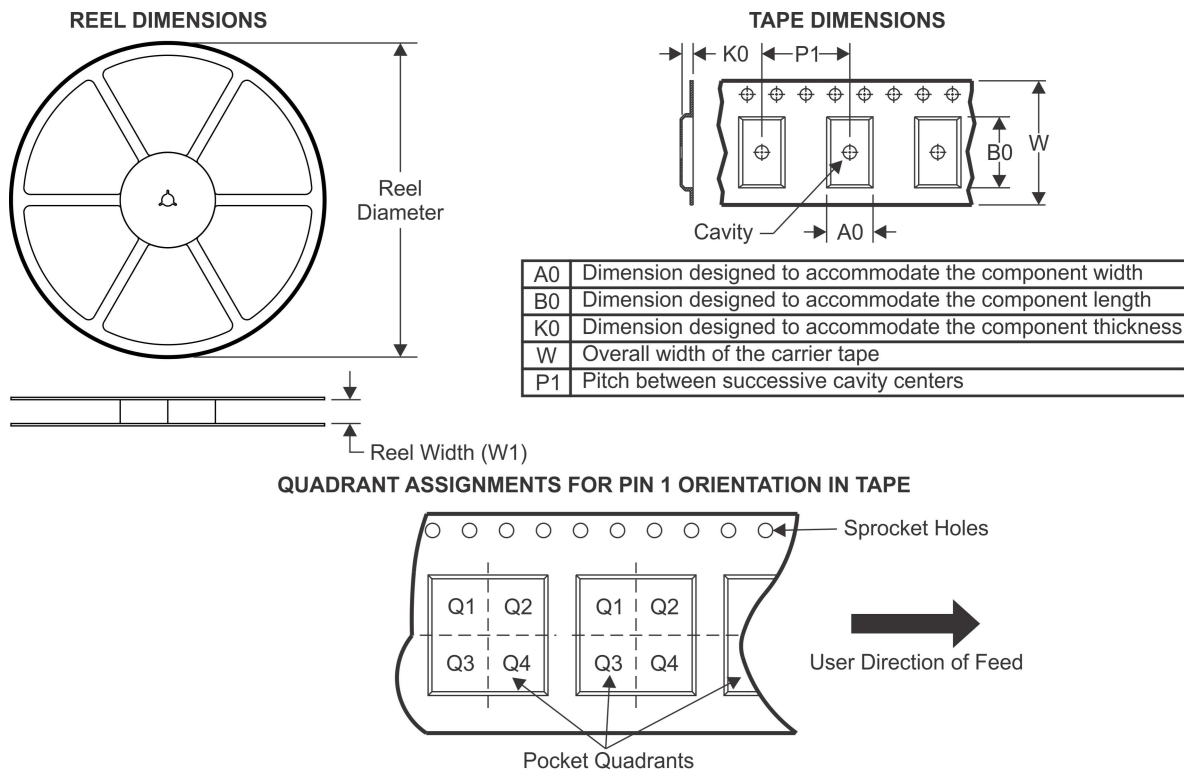
- Catalog: [SN74365A](#), [SN74366A](#), [SN74367A](#), [SN74368A](#), [SN74LS365A](#), [SN74LS366A](#), [SN74LS367A](#), [SN54LS367A](#), [SN54LS368A](#)

- Military: [SN54365A](#), [SN54366A](#), [SN54367A](#), [SN54368A](#), [SN54LS365A](#), [SN54LS366A](#), [SN54LS367A](#), [SN54LS368A](#)

- Space: [SN54LS367A-SP](#)

NOTE: Qualified Version Definitions:

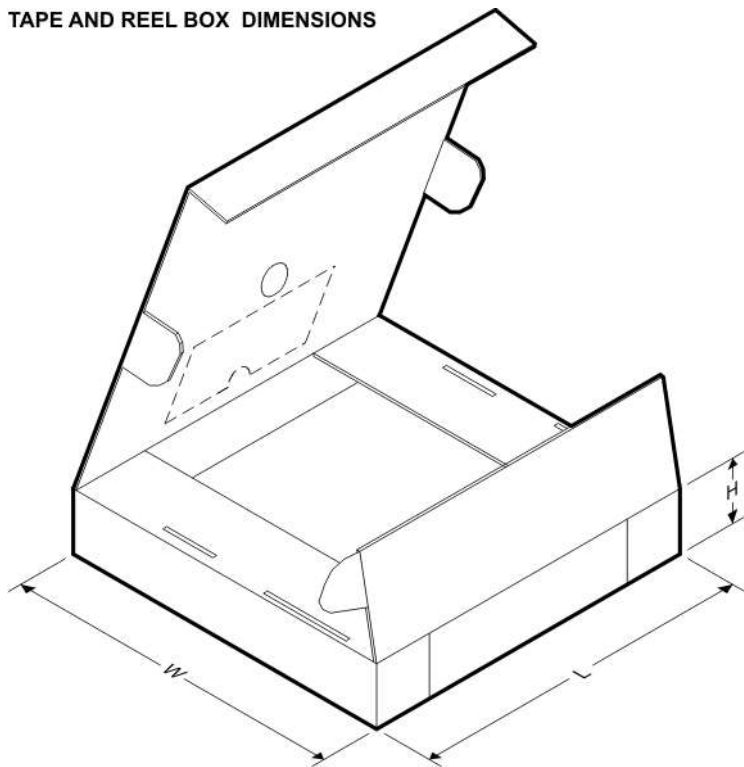
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS365ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS365ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LS367ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS368ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS368ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



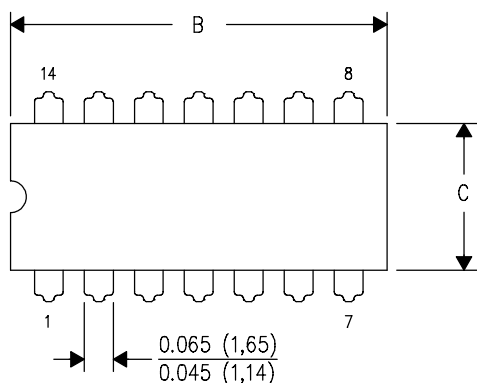
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS365ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS365ANSR	SO	NS	16	2000	367.0	367.0	38.0
SN74LS367ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS368ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74LS368ANSR	SO	NS	16	2000	367.0	367.0	38.0

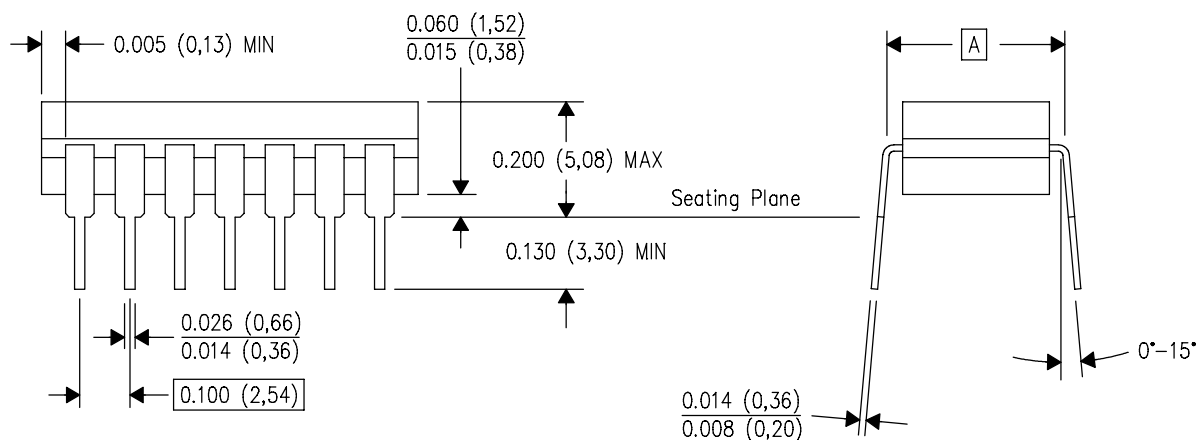
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

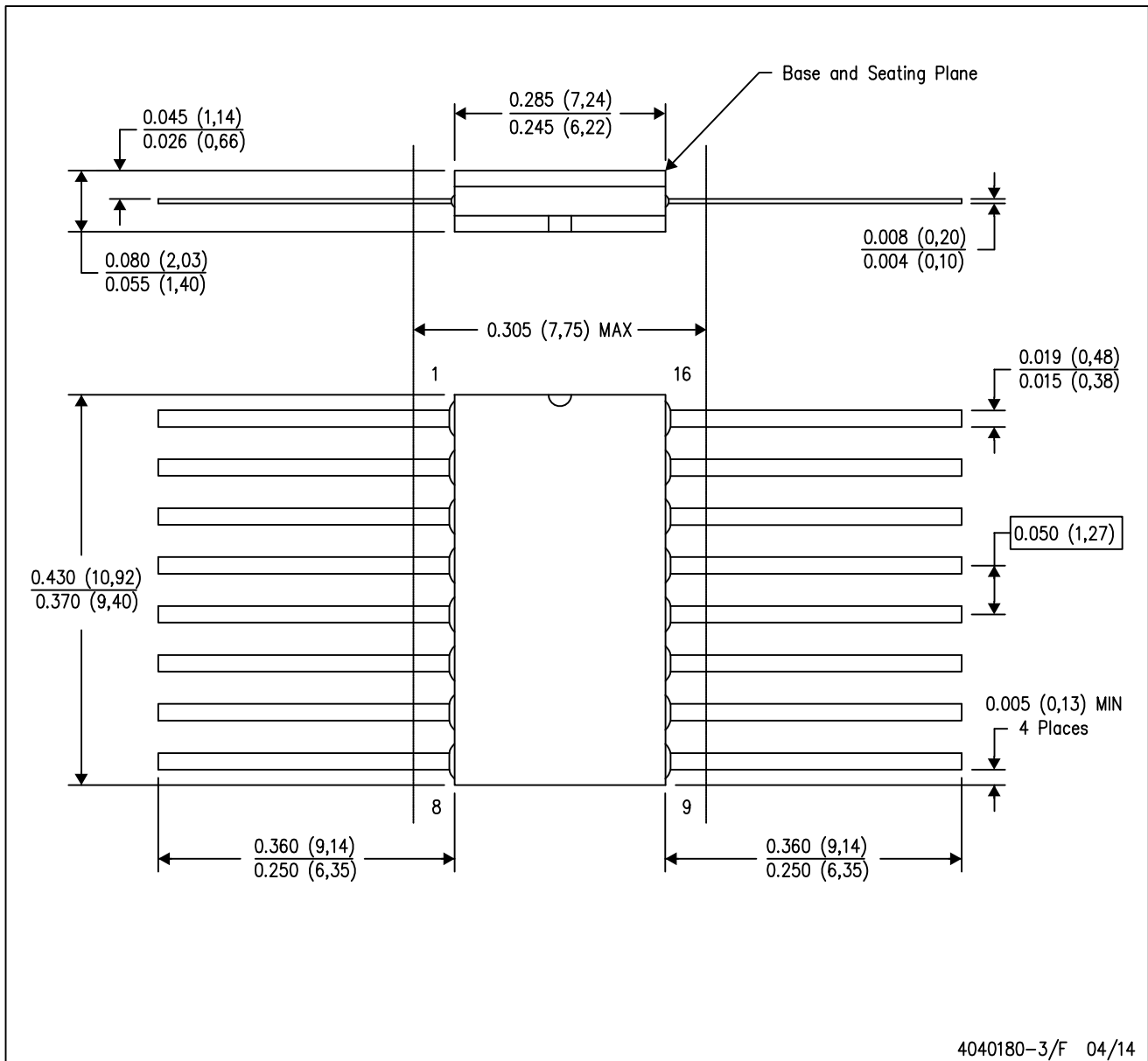


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK

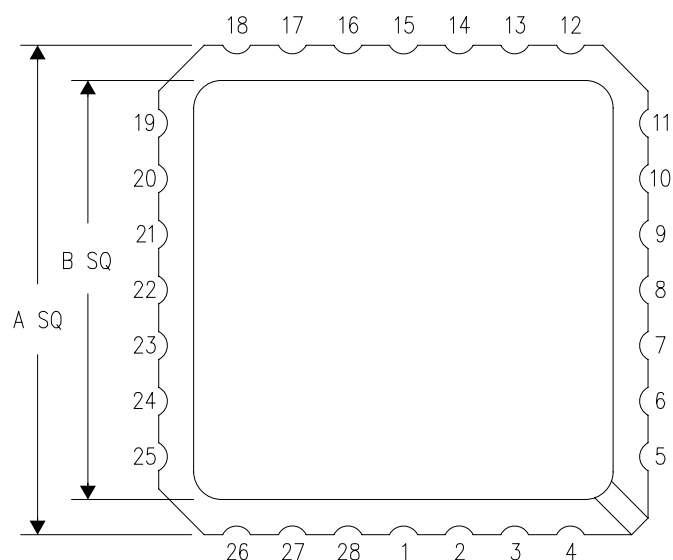


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP2-F16

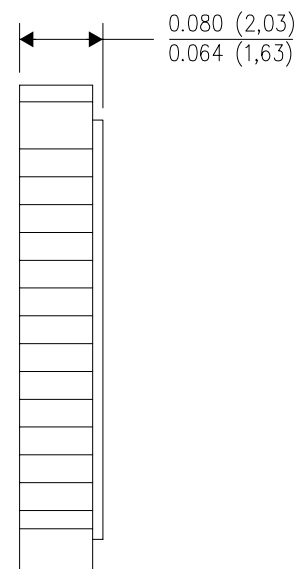
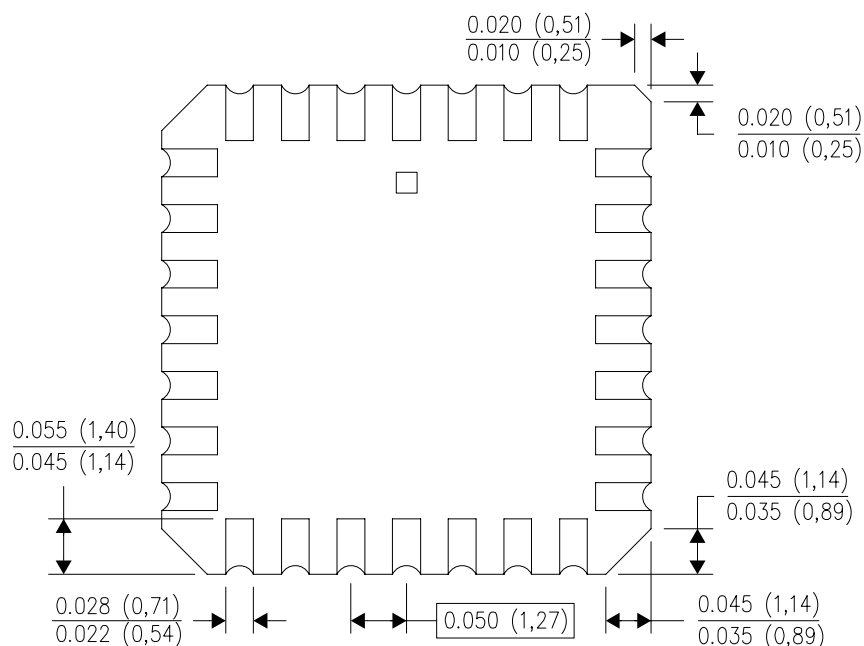
FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



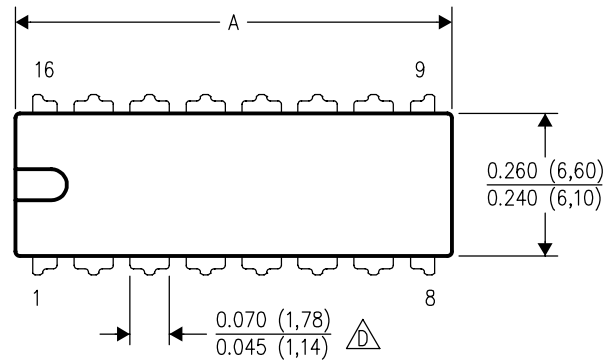
4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

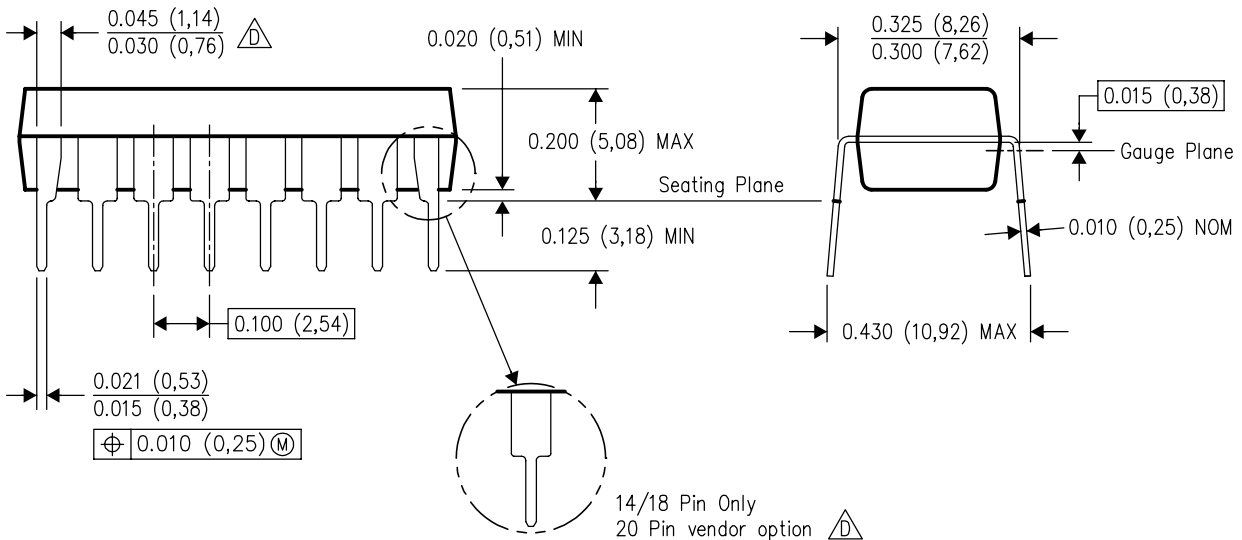
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



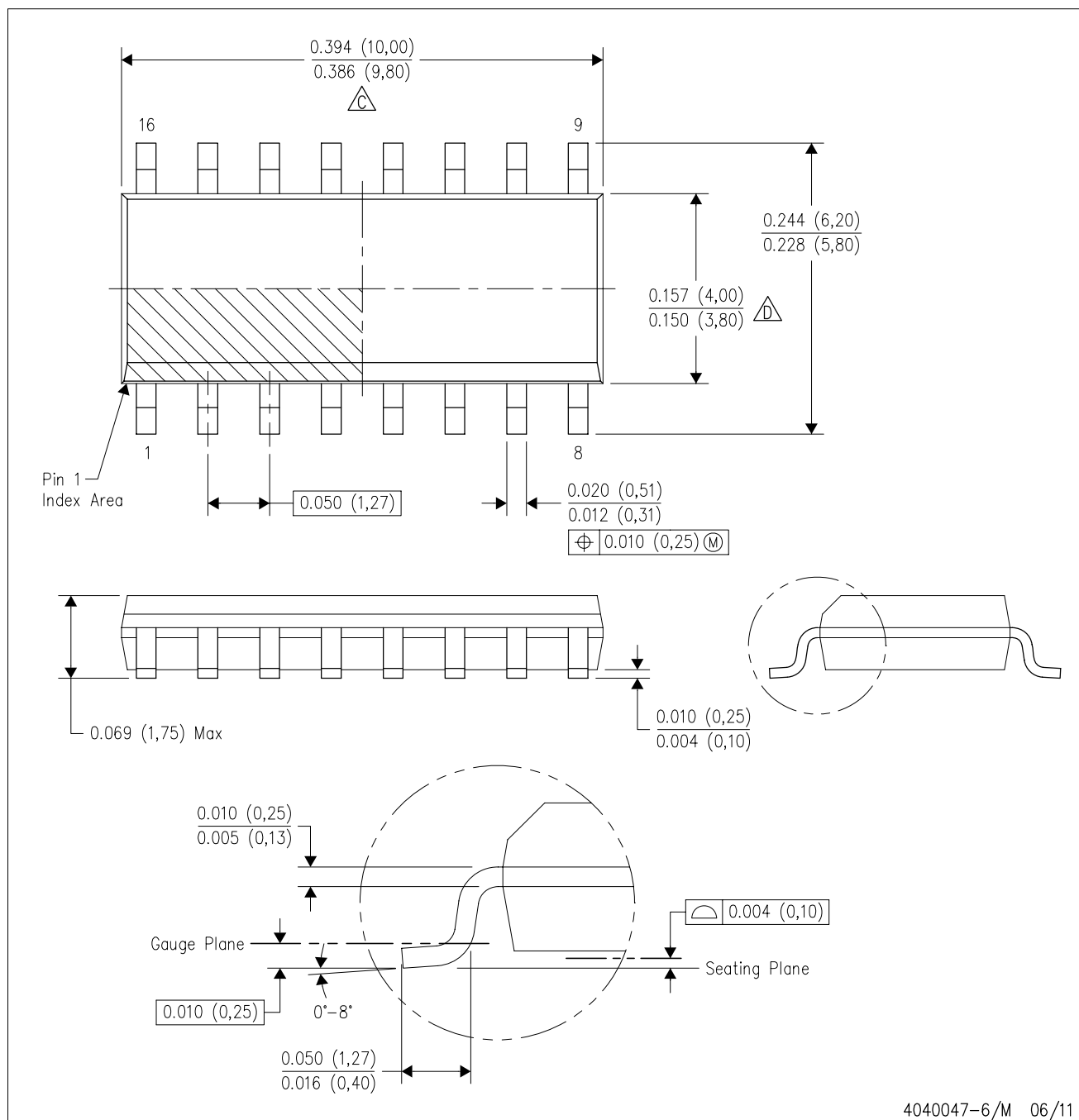
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

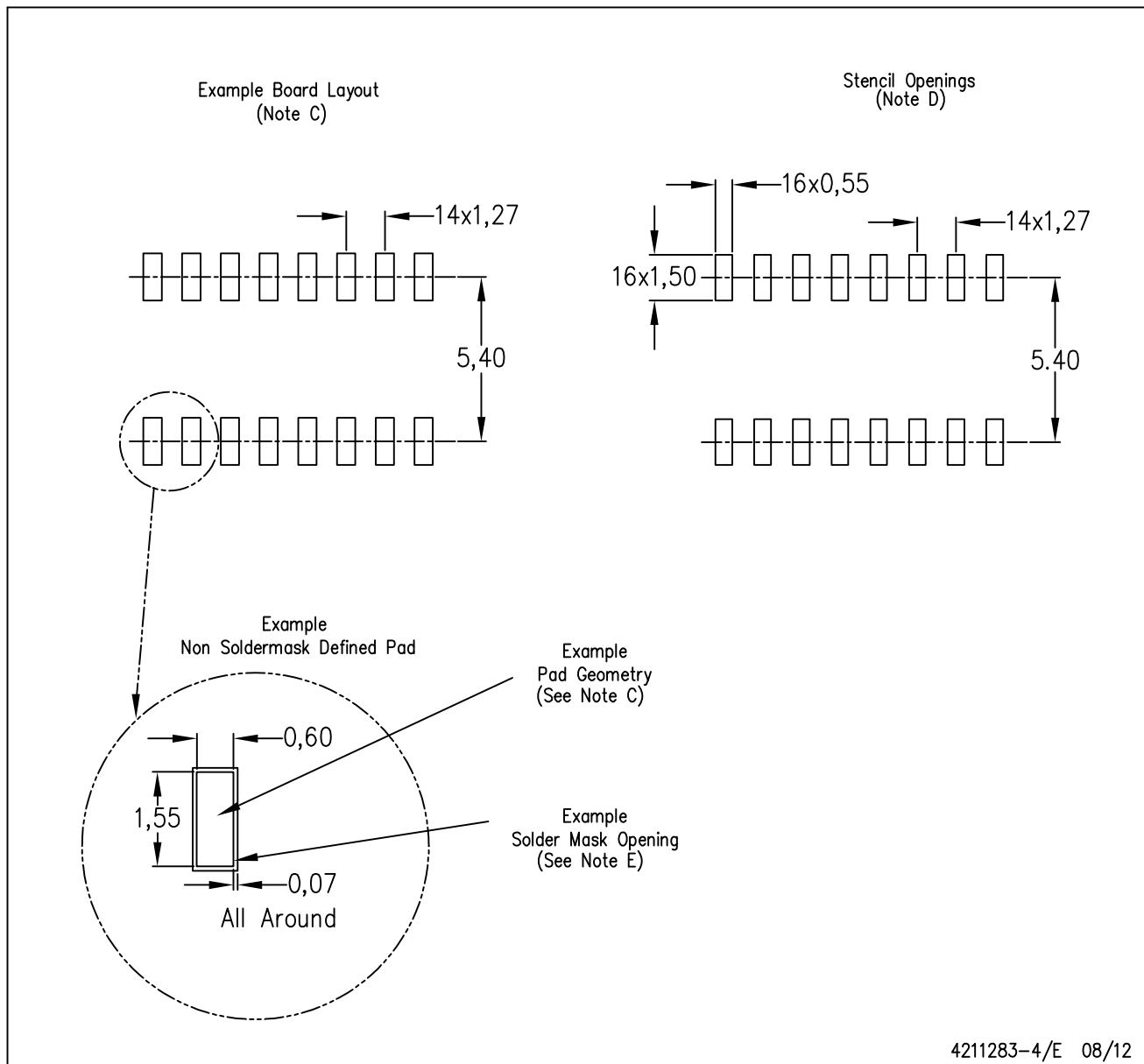
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



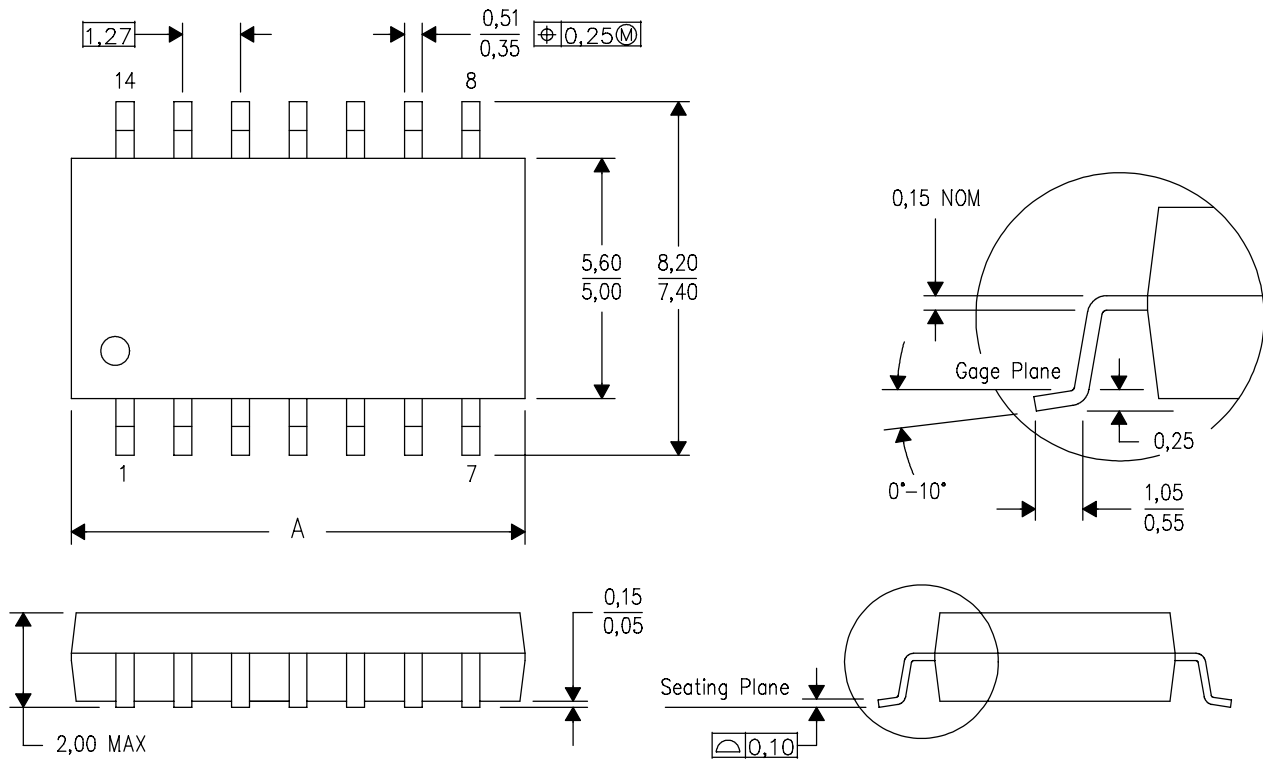
- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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